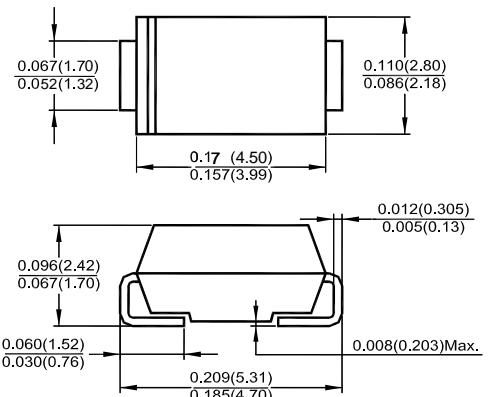


## Features

- ◊ For surface mounted application
- ◊ Easy pick and place
- ◊ Low forward voltage drop
- ◊ High current capability
- ◊ High surge current capability
- ◊ High temperature soldering guaranteed:  
260°C / 10 seconds at terminals
- ◊ Plastic material used carriers Underwriters  
Laboratory Classification 94V-0

## GS1A-GS1M



Dimensions in inches and (millimeters)

DO-214AC (SMA)

## Mechanical Data

- ◊ Case: JEDEC DO-214AA, molded plastic body over passivated chip
- ◊ Polarity: Color band denotes cathode end

## MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

Ratings at 25 °C ambient temperature unless otherwise specified. Single phase, half wave, 60 Hz, resistive or inductive load. For capacitive load, derate current by 20%.

Type Number	Symbol	GS1A	GS1B	GS1D	GS1G	GS1J	GS1K	GS1M	Units
Maximum Recurrent Peak Reverse Voltage	V <sub>RRM</sub>	50	100	200	400	600	800	1000	V
Maximum RMS Voltage	V <sub>RMS</sub>	35	70	140	280	420	560	700	V
Maximum DC Blocking Voltage	V <sub>DC</sub>	50	100	200	400	600	800	1000	V
Maximum Average Forward Rectified Current @Ta(See Fig. 1)	I <sub>(AV)</sub>	1.0						A	
Peak Forward Surge Current, 8.3 ms Single Half Sine-wave Superimposed on Rated Load (JEDEC method )	I <sub>FSM</sub>	25						A	
Maximum Instantaneous Forward Voltage (Note 1) IF= 1.0A @Ta=25°C	V <sub>F</sub>	1.1						V	
Maximum DC Reverse Current @ Ta=25°C @ Ta=125°C	I <sub>R</sub>	1.0 50.0						uA	
Typical Junction Capacitance(Note 3)	C <sub>j</sub>	15						pF	
Typical Thermal Resistance (Note 2)	R <sub>θJA</sub> R <sub>θJL</sub>	80 28						°C/W	
Operating Temperature Range	T <sub>J</sub>	-55 to +150						°C	
Storage Temperature Range	T <sub>STG</sub>	-55 to +150						°C	

Notes: 1. Pulse Test with PW=300u sec, 1% Duty Cycle.

2. Mount on Cu-Pad Size 5mm x 5mm on P.C.B.

3. Measured at f=1.0MHz, VR= 4.0V D.C.

## Typical Characteristics

**GS1A-GS1M**

FIG.1 Maximum Forward Current Derating Curve

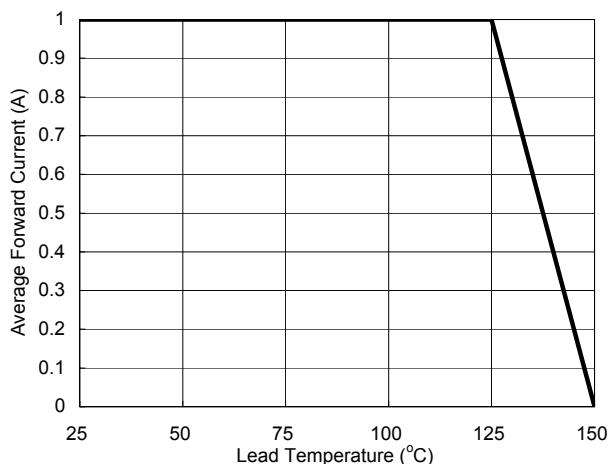


FIG 2 Maximum Forward Surge Current

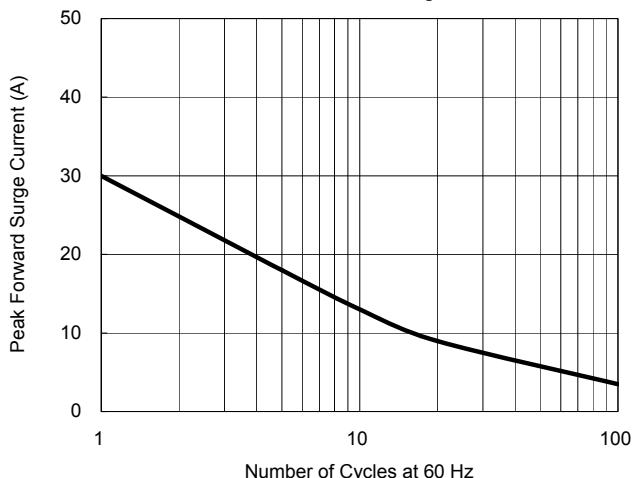


FIG 3 TYPICAL FORWARD CHARACTERISTICS

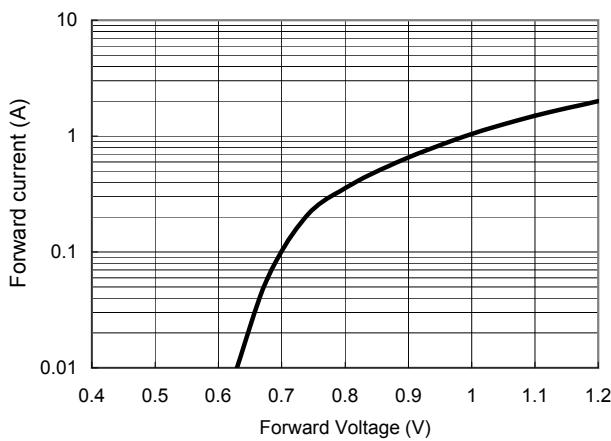


FIG 4 TYPICAL REVERSE LEAKAGE CHARACTERISTICS

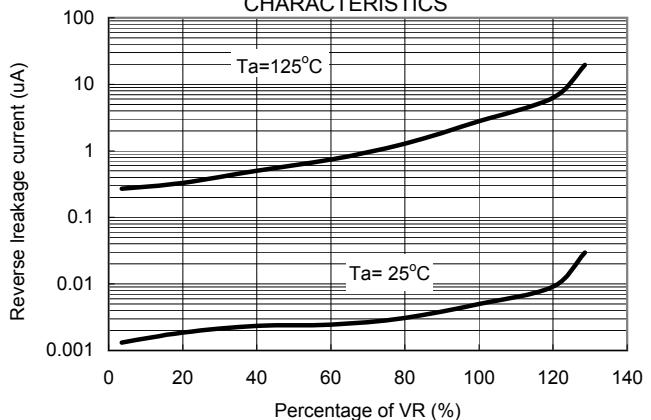


FIG 5 Typical Junction Capacitance

